



Features

- Automatic power-down when deselected
- CMOS for optimum speed/power
- High speed
 - 15 ns
- Low active power
 - 275 mW
- Low standby power
 - 83 mW
- TTL-compatible inputs and outputs
- Capable of withstanding greater than 2001V electrostatic discharge
- V_{IH} of 2.2V

Functional Description

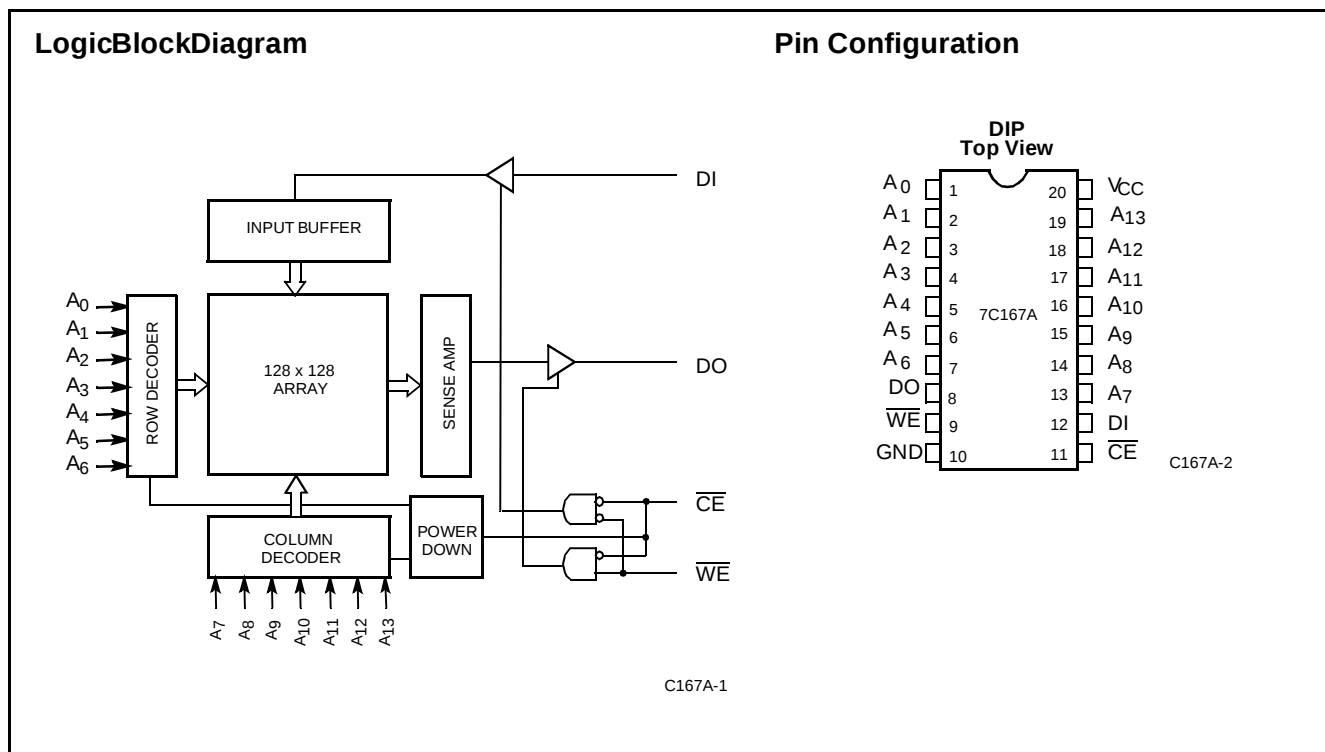
The CY7C167A is a high-performance CMOS static RAM organized as 16,384 words by 1 bit. Easy memory expansion is provided by an active LOW chip enable ($\overline{CE}$) and three-state drivers. The CY7C167A has an automatic power-down feature, reducing the power consumption by 67% when deselected.

Writing to the device is accomplished when the chip select ($\overline{CE}$) and write enable ($\overline{WE}$) inputs are both LOW. Data on the input pin (DI) is written into the memory location specified on the address pins (A_0 through A_{13}).

Reading the device is accomplished by taking the chip enable ($\overline{CE}$) LOW, while ($\overline{WE}$) remains HIGH. Under these conditions, the contents of the location specified on the address pins will appear on the data output (DO) pin.

The output pin remains in a high-impedance state when chip enable is HIGH, or write enable ($\overline{WE}$) is LOW.

A die coat is used to insure alpha immunity.



Selection Guide

		7C167A-15	7C167A-20	7C167A-25	7C167A-35	7C167A-45
Maximum Access Time (ns)		15	20	25	35	45
Maximum Operating Current (mA)	Commercial	90	80	60	60	
	Military		80	70	60	50

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature -65°C to +150°C

Ambient Temperature with
Power Applied -55°C to +125°C

Supply Voltage to Ground Potential
(Pin 20 to Pin 10) -0.5V to +7.0V

DC Voltage Applied to Outputs
in High Z State -0.5V to +7.0V

DC Input Voltage -3.0V to +7.0V

Output Current into Outputs (LOW) 20 mA

Static Discharge Voltage >2001V
(per MIL-STD-883, Method 3015)

Latch-Up Current >200 mA

Operating Range

Range	Ambient Temperature	V _{CC}
Commercial	0°C to +70°C	5V ± 10%
Military ^[1]	-55°C to +125°C	5V ± 10%

Electrical Characteristics Over the Operating Range^[2]

Parameter	Description	Test Conditions	7C167A-15		7C167A-20		7C167A-25		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
V _{OH}	Output High Voltage	V _{CC} = Min., I _{OH} = −4.0 mA	2.4		2.4		2.4		V
V _{OL}	Output Low Voltage	V _{CC} = Min., I _{OL} = 12.0 mA, 8.0 mA Mil		0.4		0.4		0.4	V
V _{IH}	Input High Voltage		2.2	V _{CC}	2.2	V _{CC}	2.2	V _{CC}	V
V _{IL}	Input Low Voltage ^[3]		−0.5	0.8	−0.5	0.8	−0.5	0.8	V
I _{IX}	Input Load Current	GND ≤ V _I ≤ V _{CC}	−10	+10	−10	+10	−10	+10	μA
I _{OZ}	Output Leakage Current	GND ≤ V _O ≤ V _{CC} Output Disabled	−10	+10	−10	+10	−10	+10	μA
I _{OS}	Output Short Circuit Current ^[4]	V _{CC} = Max., V _{OUT} = GND		−350		−350		−350	mA
I _{CC}	V _{CC} Operating Supply Current	V _{CC} = Max., I _{OUT} = 0 mA	Com'l		90		80		mA
		Mil			80		70		
I _{SB}	Automatic $\overline{\text{CE}}$ Power-Down Current ^[5]	Max. V _{CC} , $\overline{\text{CE}} \geq V_{\text{IH}}$	Com'l		40		40		mA
			Mil				40		

Parameter	Description	Test Conditions		7C167A-35		7C167A-45		Unit
				Min.	Max.	Min.	Max.	
V _{OH}	Output High Voltage	V _{CC} = Min., I _{OH} = −4.0 mA		2.4		2.4		V
V _{OL}	Output Low Voltage	V _{CC} = Min., I _{OL} = 12.0 mA, 8.0 mA Mil			0.4		0.4	V
V _{IH}	Input High Voltage			2.2	V _{CC}	2.2	V _{CC}	V
V _{IL}	Input Low Voltage ^[3]			−0.5	0.8	−0.5	0.8	V
I _{IX}	Input Load Current	GND ≤ V _I ≤ V _{CC}		−10	+10	−10	+10	μA
I _{OZ}	Output Leakage Current	GND ≤ V _O ≤ V _{CC} Output Disabled		−10	+10	−10	+10	μA
I _{OS}	Output Short Circuit Current ^[4]	V _{CC} = Max., V _{OUT} = GND			−350		−350	mA
I _{CC}	V _{CC} Operating Supply Current	V _{CC} = Max., I _{OUT} = 0 mA	Com'l		60		50	mA
			Mil		60		50	
I _{SB}	Automatic CE Power-Down Current ^[5]	Max. V _{CC} , CE ≥ V _{IH}	Com'l		20			mA
				Mil		20		

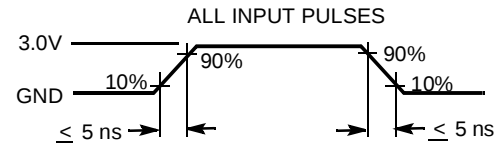
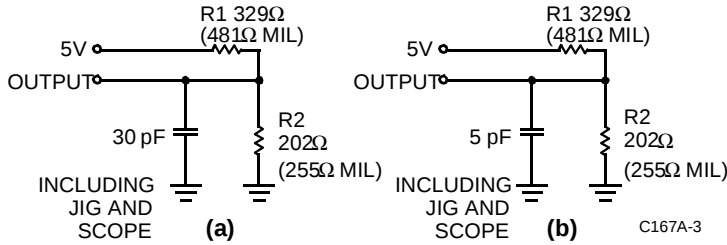
Notes:

1. T_A is the "instant on" case temperature.
2. See the last page of this specification for Group A subgroup testing information.
3. V_{IL} min. = -3.0V for pulse durations less than 30 ns.
4. Duration of the short circuit should not exceed 30 seconds.
5. A pull-up resistor to V_{CC} on the $\overline{\text{CE}}$ input is required to keep the device deselected during V_{CC} power-up, otherwise I_{SB} will exceed values given.

Capacitance^[6]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	T _A = 25°C, f = 1 MHz, V _{CC} = 5.0V	10	pF
C _{OUT}	Output Capacitance		10	pF
C _{CE}	Chip Enable Capacitance		6	pF

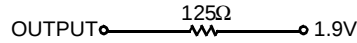
AC Test Loads and Waveforms



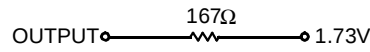
C167A-4

Equivalent to:

THÉVENIN EQUIVALENT



Commercial



Military

Switching Characteristics Over the Operating Range^[2, 7]

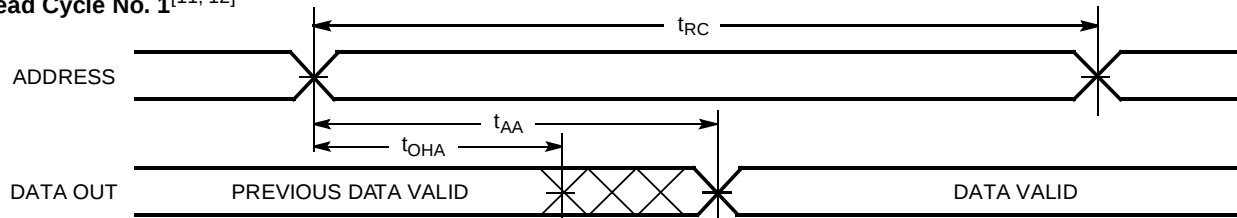
Parameter	Description		7C167A-15		7C167A-20		7C167A-25		7C167A-35		7C167A-45		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
READ CYCLE													
t _{RC}	Read Cycle Time	Com'l	15		20		25		30				ns
		Mil			20		25		35		40		ns
t _{AA}	Address to Data Valid	Com'l		15		20		25		30			ns
		Mil				20		25		35		40	ns
t _{OHA}	Data Hold from Address Change		5		5		5		5		5		ns
t _{ACE}	$\overline{\text{CE}}$ LOW to Data Valid			15		20		25		35		45	ns
t _{LZCE}	$\overline{\text{CE}}$ LOW to Low Z ^[8]		5		5		5		5		5		ns
t _{HZCE}	$\overline{\text{CE}}$ HIGH to High Z ^[8, 9]			8		8		10		15		15	ns
t _{PU}	$\overline{\text{CE}}$ LOW to Power-Up		0		0		0		0		0		ns
t _{PD}	$\overline{\text{CE}}$ HIGH to Power-Down			15		20		20		20		25	ns
WRITE CYCLE ^[10]													
t _{WC}	Write Cycle Time		15		20		20		25		40		ns
t _{SCE}	$\overline{\text{CE}}$ LOW to Write End		12		15		20		25		30		ns
t _{AW}	Address Set-Up to Write End		12		15		20		25		30		ns
t _{HA}	Address Hold from Write End		0		0		0		0		0		ns
t _{SA}	Address Set-Up to Write Start		0		0		0		0		0		ns
t _{PWE}	$\overline{\text{WE}}$ Pulse Width		12		15		15		20		20		ns
t _{SD}	Data Set-Up to Write End		10		10		10		15		15		ns
t _{HD}	Data Hold from Write End		0		0		0		0		0		ns
t _{HZWE}	$\overline{\text{WE}}$ LOW to High Z ^[8, 9]			7		7		7		10		15	ns
t _{LZWE}	$\overline{\text{WE}}$ HIGH to Low Z ^[8]		5		5		5		5		5		ns

Notes:

- Tested initially and after any design or process changes that may affect these parameters.
- Test conditions assume signal transition times of 5 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 30-pF load capacitance.
- At any given temperature and voltage condition, t_{HZ} is less than t_{LZ} for any given device.
- t_{HZCE} and t_{HZWE} are tested with C_L = 5 pF as in part (b) of AC Test Loads. Transition is measured ±500 mV from steady state voltage.
- The internal write time of the memory is defined by the overlap of CE LOW and WE LOW. Both signal must be LOW to initiate a write and either signal can terminate a write by going HIGH. The data input set-up and hold timing should be referenced to the rising edge of the signal that terminates the write.

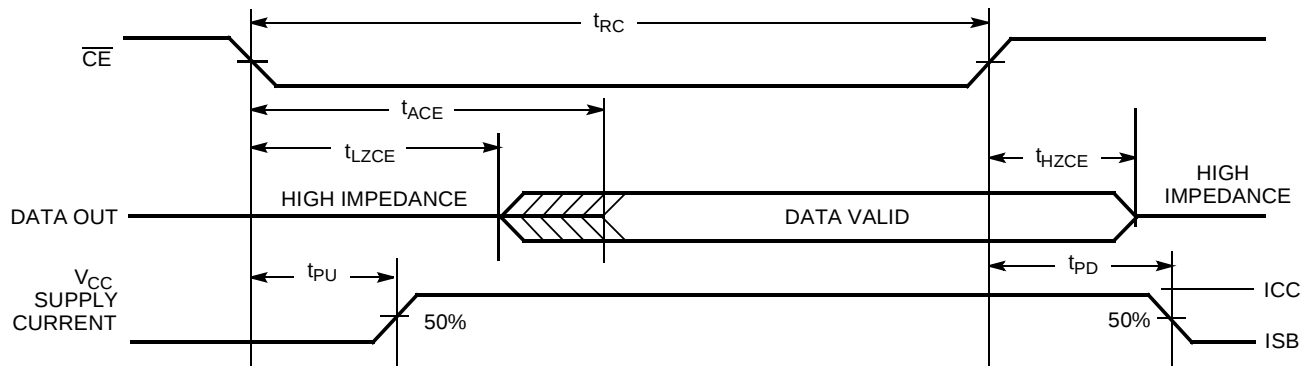
Switching Waveforms

Read Cycle No. 1^[11, 12]



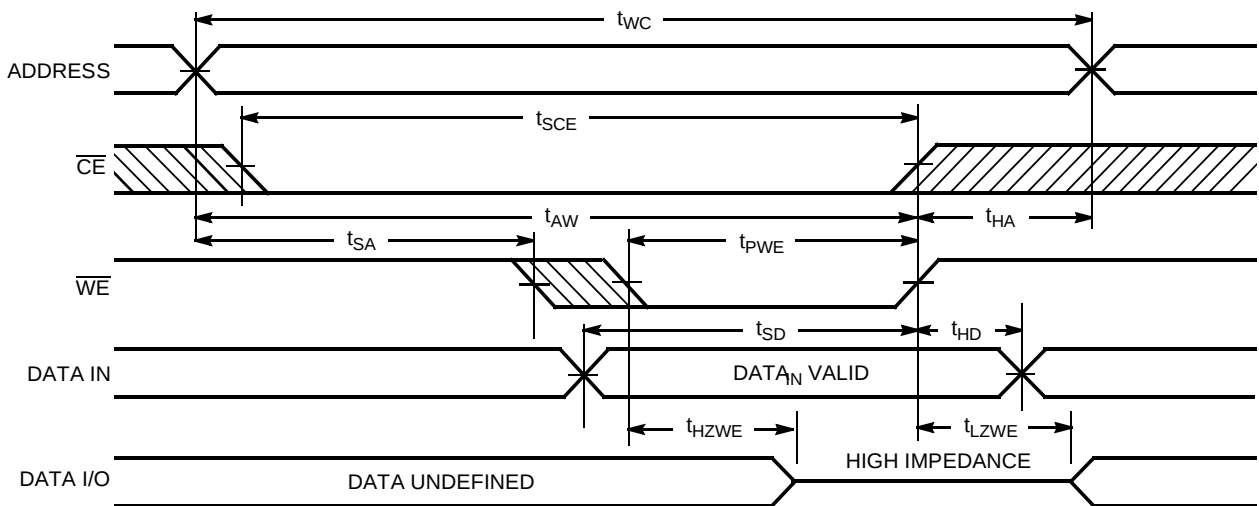
C167A-5

Read Cycle No. 2^[11, 13]



C167A-6

Write Cycle No. 1 ($\overline{WE}$ Controlled)^[10]



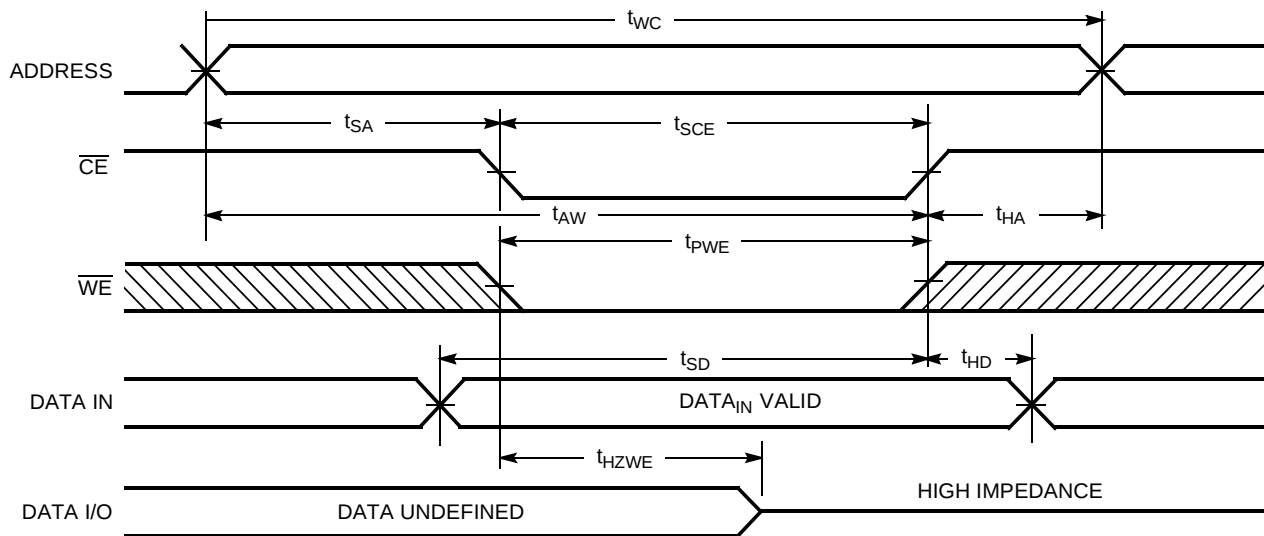
C167A-7

Notes:

11. $\overline{WE}$ is high for read cycle.
12. Device is continuously selected, $\overline{CE} = V_{IL}$.
13. Address valid prior to or coincident with $\overline{CE}$ transition LOW.
14. If CE goes HIGH simultaneously with WE HIGH, the output remains in a high-impedance state.

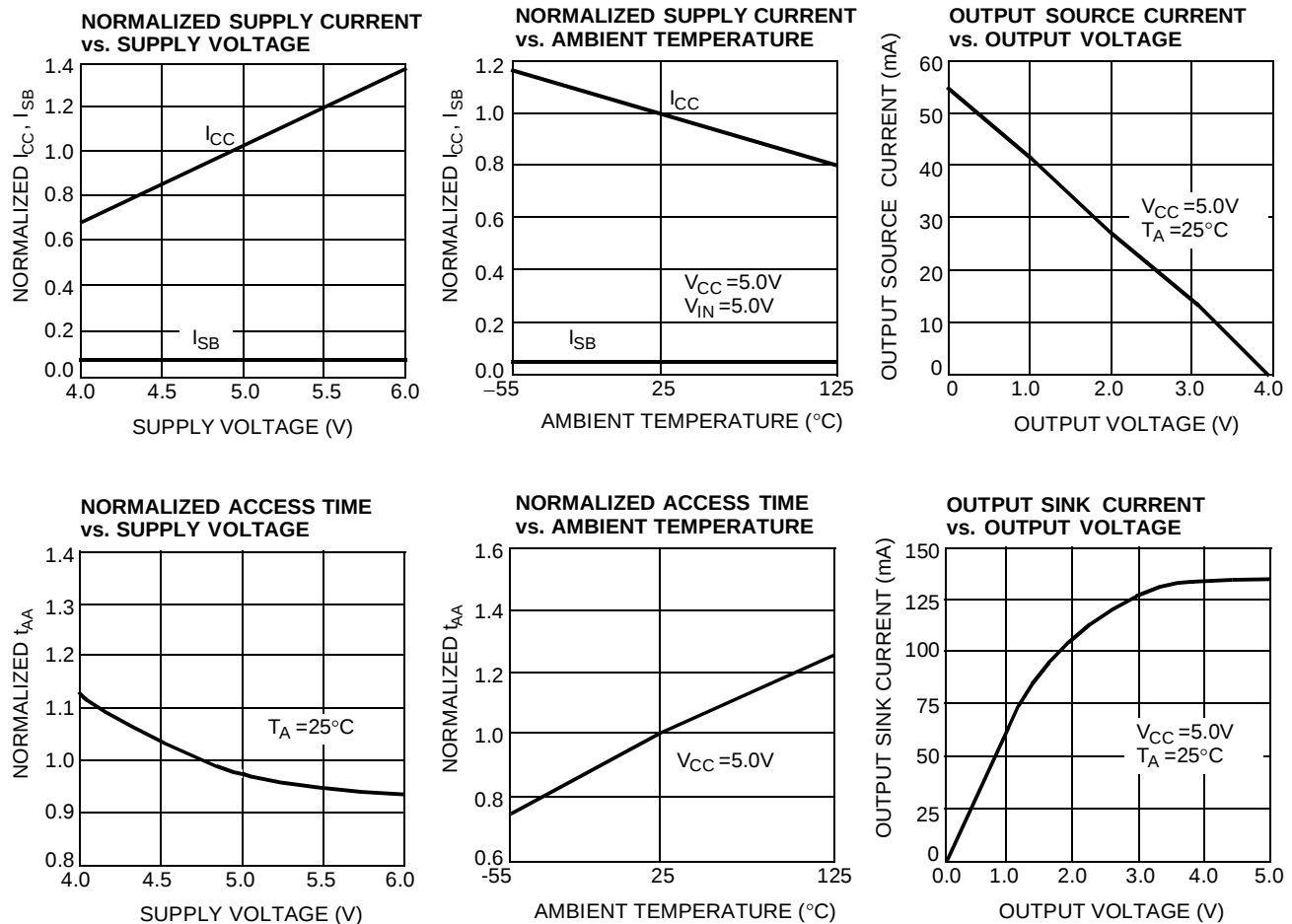
Switching Waveforms (continued)

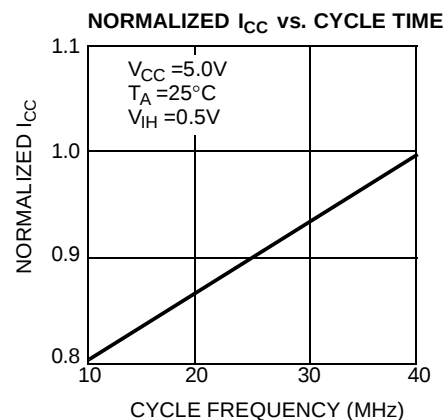
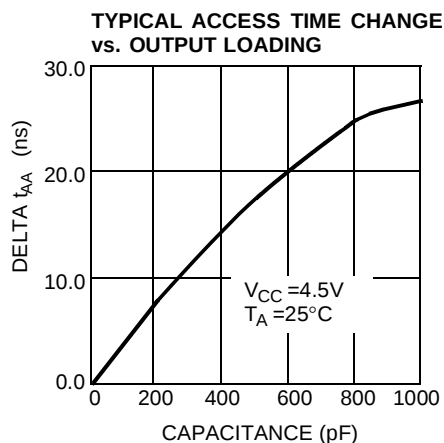
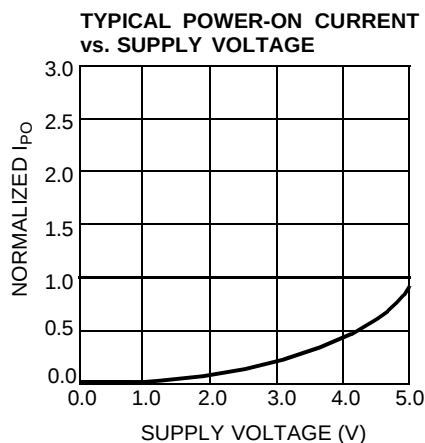
Write Cycle No. 2 ($\overline{\text{CE}}$ Controlled)^[10, 14]



C167A-8

Typical DC and AC Characteristics



Typical DC and AC Characteristics (continued)

Ordering Information

Speed (ns)	I_{CC} (mA)	Ordering Code	Package Name	Package Type	Operating Range
15	80	CY7C167A-15PC	P5	20-Lead (300-Mil) Molded DIP	Commercial
		CY7C167A-15VC	V5	20-Lead Molded SOJ	
20	80	CY7C167A-20PC	P5	20-Lead (300-Mil) Molded DIP	Commercial
		CY7C167A-20VC	V5	20-Lead Molded SOJ	
		CY7C167A-20DMB	D6	20-Lead (300-Mil) CerDIP	Military
25	60	CY7C167A-25PC	P5	20-Lead (300-Mil) Molded DIP	Commercial
		CY7C167A-25VC	V5	20-Lead Molded SOJ	
		CY7C167A-25DMB	D6	20-Lead (300-Mil) CerDIP	Military
35	60	CY7C167A-35PC	P5	20-Lead (300-Mil) Molded DIP	Commercial
		CY7C167A-35VC	V5	20-Lead Molded SOJ	
		CY7C167A-35DMB	D6	20-Lead (300-Mil) CerDIP	Military
45	50	CY7C167A-45DMB	D6	20-Lead (300-Mil) CerDIP	Military

MILITARY SPECIFICATIONS
Group A Subgroup Testing
DC Characteristics

Parameter	Subgroups
V_{OH}	1,2,3
V_{OL}	1,2,3
V_{IH}	1,2,3
V_{IL} Max.	1,2,3
I_{IX}	1,2,3
I_{OZ}	1,2,3
I_{CC}	1,2,3
I_{SB}	1,2,3

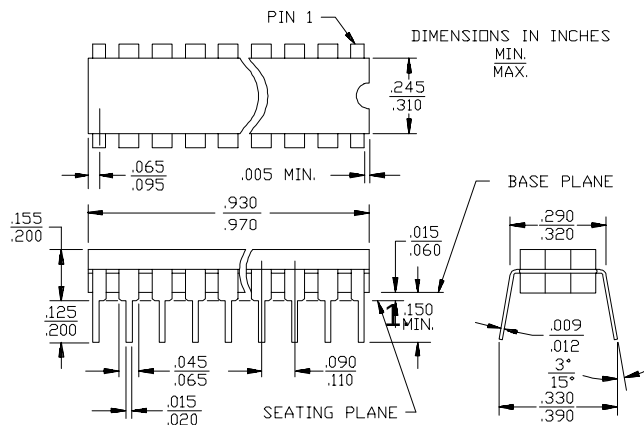
Document #: 38-00093-C

Switching Characteristics

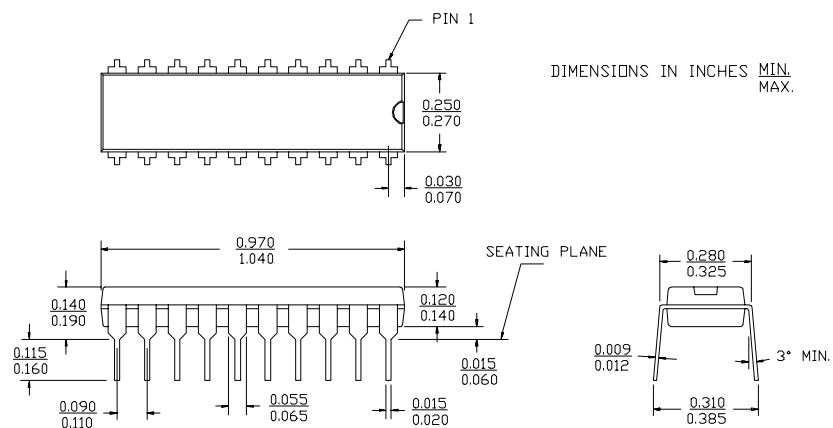
Parameter	Subgroups
READ CYCLE	
t_{RC}	7,8,9,10,11
t_{AA}	7,8,9,10,11
t_{OHA}	7,8,9,10,11
t_{ACE}	7,8,9,10,11
WRITE CYCLE	
t_{WC}	7,8,9,10,11
t_{SCE}	7,8,9,10,11
t_{AW}	7,8,9,10,11
t_{HA}	7,8,9,10,11
t_{SA}	7,8,9,10,11
t_{PWE}	7,8,9,10,11
t_{SD}	7,8,9,10,11
t_{HD}	7,8,9,10,11

Package Diagrams

20-Lead (300-Mil) CerDIP D6 MIL-STD-1835 D-8 Config. A

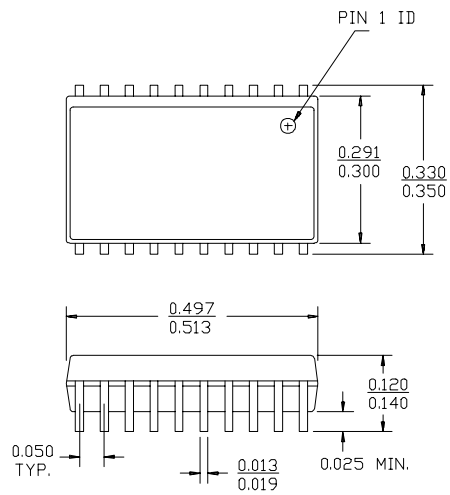


20-Lead (300-Mil) Molded DIP P5



Package Diagrams (continued)

20-Lead Molded SOJ V5



DIMENSIONS IN INCHES MIN.
MAX.

